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Request a Quote Section PCIe-6363

SPECIFICATIONS

# PCIe-6363

PCI Express, 32 AI (16-Bit, 2 MS/s), 4 AO (2.86 MS/s), 48 DIO Multifunction I/O Device

### Definitions

*Warranted* specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

*Characteristics* describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- *Typical* specifications describe the performance met by a majority of models.
- *Nominal* specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are Typical unless otherwise noted.

## Conditions

Specifications are valid at 25 °C unless otherwise noted.

## Analog Input

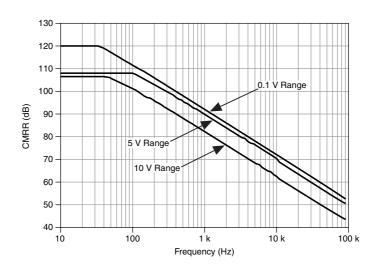
Number of channels	32 single-ended or 16 differential
ADC resolution	16 bits
DNL	No missing codes guaranteed
INL	Refer to AI Absolute Accuracy.



Sample rate

Single channel maximum	2.00 MSample/s
Multichannel maximum (aggregate)	1.00 MSample/s
Minimum	No minimum
Timing resolution	10 ns
Timing accuracy	50 ppm of sample rate
Input coupling	DC
Input range	±0.1 V, ±0.2 V, ±0.5 V, ±1 V, ±2 V, ±5 V, ±10 V
Maximum working voltage for analog inputs (signal + common mode)	±11 V of AI GND
CMRR (DC to 60 Hz)	100 dB

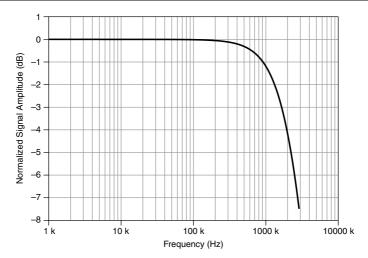
Figure 1. Al <0..31> CMRR



out impedance	
Device on	
AI+ to AI GND	$>10 \text{ G}\Omega$ in parallel with 100 pl
AI- to AI GND	$>10 \text{ G}\Omega$ in parallel with 100 pl
Device off	
AI+ to AI GND	820 Ω
AI- to AI GND	820 Ω
out bias current	±100 pA

Crosstalk (at 100 kHz)		
Adjacent channels	-75 dB	
Non-adjacent channels	-95 dB	
Small signal bandwidth (-3 dB)	1.7 MHz	

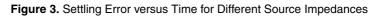


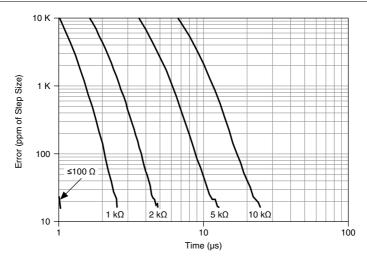


Input FIFO size	2,047 samples
Scan list memory	4,095 entries
Data transfers	DMA (scatter-gather), programmed I/O
Overvoltage protection for all analog input a	nd sense channels
Device on	±25 V for up to two AI pins
Device off	$\pm 15$ V for up to two AI pins
Input current during overvoltage condition	±20 mA max/AI pin

#### Table 1. Settling Time for Multichannel Measurements

Range	±60 ppm of Step (±4 LSB for Full-Scale Step)	±15 ppm of Step (±1 LSB for Full-Scale Step)
$\pm 10 \text{ V}, \pm 5 \text{ V}, \pm 2 \text{ V}, \pm 1 \text{ V}$	1 µs	1.5 μs
±0.5 V	1.5 μs	2 µs
±0.2 V, ±0.1 V	2 µs	8 µs





### Analog Triggers

1
AI <031>, APFI <0,1>
Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Convert Clock, Sample Clock Timebase
±Full scale
±10 V
16 bits
Analog edge triggering, analog edge triggering with hysteresis, analog window triggering
3.4 MHz
3.9 MHz
±1% of range
10 kΩ
DC

Protection		
Power on	±30 V	
Power off	±15 V	

#### Al Absolute Accuracy (Warranted)

Nominal Range Positive Full Scale (V)	Nominal Range Negative Full Scale (V)	Residual Gain Error (ppm of Reading)	Residual Offset Error (ppm of Range)	Offset Tempco (ppm of Range/°C)	Random Noise, σ (μVrms)	Absolute Accuracy at Full Scale (μV)
10	-10	48	13	21	315	1,660
5	-5	55	13	21	157	870
2	-2	55	13	24	64	350
1	-1	65	17	27	38	190
0.5	-0.5	68	17	34	27	100
0.2	-0.2	95	27	55	21	53
0.1	-0.1	108	45	90	17	33

#### Table 2. Al Absolute Accuracy



**Note** *Absolute Accuracy at Full Scale* is determined using the following assumptions:

- TempChangeFromLastExternalCal = 10 °C
- TempChangeFromLastInternalCal = 1 °C
- NumberOfReadings = 10,000
- CoverageFactor =  $3 \sigma$



**Note** Accuracies listed are valid for up to two years from the device external calibration.

Gain tempco	13 ppm/°C
Reference tempco	1 ppm/°C
INL error	60 ppm of range

#### Al Absolute Accuracy Equation

AbsoluteAccuracy = Reading · (GainError) + Range · (OffsetError) + NoiseUncertainty GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal) OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INLError

NoiseUncertainty =  $\frac{\text{Random Noise} \cdot 3}{\sqrt{10,000}}$  for a coverage factor of 3  $\sigma$  and averaging 10,000 points.

#### Al Absolute Accuracy Example

For example, on the 10 V range, the absolute accuracy at full scale is as follows: GainError: 48 ppm + 13 ppm  $\cdot$  1 + 1 ppm  $\cdot$  10 = 71 ppm OffsetError: 13 ppm + 21 ppm  $\cdot$  1 + 60 ppm = 94 ppm NoiseUncertainty:  $\frac{315 \,\mu V \cdot 3}{\sqrt{10,000}} = 9.4 \,\mu V$ AbsoluteAccuracy: 10 V  $\cdot$  (GainError) + 10 V  $\cdot$  (OffsetError) + NoiseUncertainty = 1,660  $\mu V$ 

### Analog Output

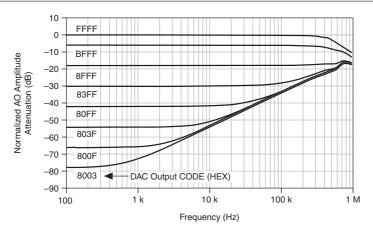
Number of channels	4
DAC resolution	16 bits
DNL	±1 LSB
Monotonicty	16 bit guaranteed
Maximum update rate (simultaneous)	
1 channel	2.86 MSample/s
2 channels	2.00 MSample/s
3 channels	1.54 MSample/s
4 channels	1.25 MSample/s
Timing accuracy	50 ppm of sample rate
Timing resolution	10 ns
Output range	$\pm 10 \text{ V}, \pm 5 \text{ V}, \pm \text{external reference on}$ APFI <0,1>
Output coupling	DC
Output impedance	0.2 Ω
Output current drive	±5 mA
Overdrive protection	±25 V
Overdrive current	26 mA
Power-on state	±5 mV
Power-on/off glitch	1.5 V peak for 200 ms

Output FIFO size	8,191 samples shared among channels used
Data transfers	DMA (scatter-gather), programmed I/O
AO waveform modes	Non-periodic waveform, periodic waveform regeneration mode from onboard FIFO, periodic waveform regeneration from host buffer including dynamic update
Settling time, full-scale step 15 ppm (1 LSB)	2 µs
Slew rate	20 V/µs
Glitch energy at midscale transition, ±10 V range	10 nV · s

#### **External Reference**

APFI <0,1> characteristics	
Input impedance	10 kΩ
Coupling	DC
Protection, device on	±30 V
Protection, device off	±15 V
Range	±11 V
Slew rate	20 V/µs

#### Figure 4. AO <0..3> External Reference Bandwidth



#### AO Absolute Accuracy (Warranted)

Nominal Range Positive Full Scale (V)	Nominal Range Negative Full Scale (V)	Residual Gain Error (ppm of Reading)	Gain Tempco (ppm/ °C)	Reference Tempco (ppm/°C)	Residual Offset Error (ppm of Range)	Offset Tempco (ppm of Range/ °C)	INL Error (ppm of Range)	Absolute Accuracy at Full Scale (µV)
10	-10	63	17	1	33	2	64	1,890
5	-5	70	8	1	33	2	64	935

Table 3. AO Absolute Accuracy



**Note** *Absolute Accuracy at Full Scale* numbers are valid immediately following self calibration and assumes the device is operating within 10 °C of the last external calibration.



**Note** Accuracies listed are valid for up to two years from the device external calibration.

#### AO Absolute Accuracy Equation

AbsoluteAccuracy = OutputValue · (GainError) + Range · (OffsetError) GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal) OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INLError

### Digital I/O/PFI

#### **Static Characteristics**

Number of channels	48 total, 32 (P0.<031>), 16 (PFI <07>/P1, PFI <815>/P2)
Ground reference	D GND
Direction control	Each terminal individually programmable as input or output

Pull-down resistor

Typical	50 kΩ
Minimum	20 kΩ
Input voltage protection	$\pm 20$ V on up to two pins



**Caution** Stresses beyond those listed under the *Input voltage protection* specification may cause permanent damage to the device.

#### Waveform Characteristics (Port 0 Only)

Terminals used	Port 0 (P0.<031>)
Port/sample size	Up to 32 bits
Waveform generation (DO) FIFO	2,047 samples
Waveform acquisition (DI) FIFO	255 samples
DI Sample Clock frequency	0 MHz to 10 MHz, system and bus activity dependent
DO Sample Clock frequency	
Regenerate from FIFO	0 MHz to 10 MHz
Streaming from memory	0 MHz to 10 MHz, system and bus activity dependent
Data transfers	DMA (scatter-gather), programmed I/O
Digital line filter settings	160 ns, 10.24 µs, 5.12 ms, disable

#### PFI/Port1/Port 2 Functionality

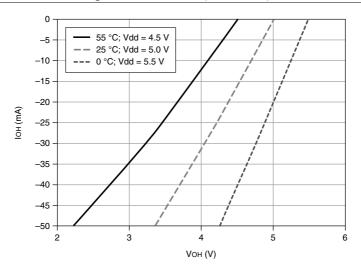
Functionality	Static digital input, static digital output, timing input, timing output
Timing output sources	Many AI, AO, counter, DI, DO timing signals
Debounce filter settings	90 ns, 5.12 μs, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

### **Recommended Operating Conditions**

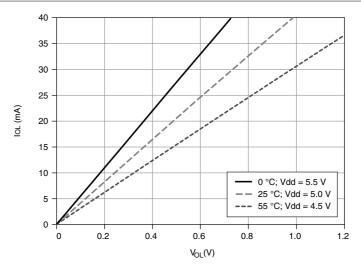
Input high voltage (V <sub>IH</sub> )		
Minimum	2.2 V	
Maximum	5.25 V	
Input low voltage (V <sub>IL</sub> )		
Minimum	0 V	
Maximum	0.8 V	
Output high current (I <sub>OH</sub> )		
P0.<031>	-24 mA maximum	
PFI <015>/P1/P2	-16 mA maximum	
Output low current (I <sub>OL</sub> )		
P0.<031>	24 mA maximum	
PFI <015>/P1/P2	16 mA maximum	

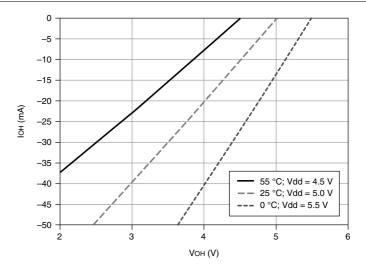
### **Digital I/O Characteristics**

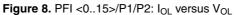
Positive-going threshold (VT+)	2.2 V maximum
Negative-going threshold (VT-)	0.8 V minimum
Delta VT hysteresis (VT+ - VT-)	0.2 V minimum
$I_{IL}$ input low current ( $V_{IN} = 0 V$ )	-10 µA maximum
$I_{IH}$ input high current ( $V_{IN} = 5 V$ )	250 μA maximum

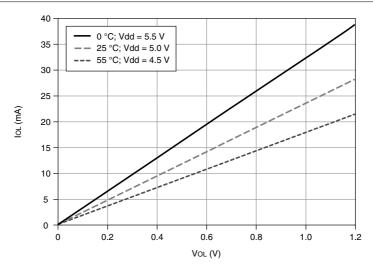












#### **General-Purpose Counters**

Number of counter/timers	4
Resolution	32 bits

Counter measurements	Edge counting, pulse, pulse width, semi-period, period, two-edge separation
Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	100 MHz, 20 MHz, 100 kHz
External base clock frequency	0 MHz to 25 MHz
Base clock accuracy	50 ppm
Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Routing options for inputs	Any PFI, RTSI, analog trigger, many internal signals
FIFO	127 samples per counter
Data transfers	Dedicated scatter-gather DMA controller for each counter/timer, programmed I/O

## **Frequency Generator**

Number of channels	1
Base clocks	20 MHz, 10 MHz, 100 kHz
Divisors	1 to 16
Base clock accuracy	50 ppm

## Phase-Locked Loop (PLL)

Number of PLLs	1
Reference clock locking frequency	
RTSI <07>	10 MHz, 20 MHz
PFI <015>	10 MHz, 20 MHz
Output of PLL	100 MHz Timebase; other signals derived from 100 MHz Timebase including 20 MHz and 100 kHz Timebases

## **External Digital Triggers**

Source	Any PFI, RTSI
Polarity	Software-selectable for most signals
Analog input function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Convert Clock, Sample Clock Timebase
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Counter/timer functions	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Digital waveform generation (DO) function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Digital waveform acquisition (DI) function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase

#### Device-to-Device Trigger Bus

Input source	RTSI <07>
Output destination	RTSI <07>
Output selections	10 MHz Clock; frequency generator output; many internal signals
Debounce filter settings	90 ns, 5.12 $\mu$ s, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

#### **Bus Interface**

Form factor	x1 PCI Express, specification v1.1 compliant	
Slot compatibility	x1, x4, x8, and x16 PCI Express slots <sup>1</sup>	
DMA channels	8, can be used for analog input, analog output, digital input, digital output, counter/timer 0, counter/timer 1, counter/timer 2, counter/timer 3	

<sup>&</sup>lt;sup>1</sup> Some motherboards reserve the x16 slot for graphics use. For PCI Express guidelines, visit ni.com/ info and enter the Info Code pciexpress.

### **Power Requirements**



**Caution** The protection provided by the device can be impaired if the device is used in a manner not described in the *X Series User Manual*.

#### Without disk drive power connector installed

•		
+3.3 V	4.6 W	
+12 V	5.4 W	
With disk drive power connec	tor installed	
+3.3 V	1.6 W	
+12 V	5.4 W	
+5 V	15 W	

#### **Current Limits**

**Caution** Exceeding the current limits may cause unpredictable device behavior.

Without disk drive power connector install	led
P0/PFI/P1/P2 and +5 V terminals combined	0.59 A maximum
With disk drive power connector installed	
+5 V terminal (connector 0)	1 A maximum <sup>2</sup>
+5 V terminal (connector 1)	1 A maximum <sup>2</sup>
P0/PFI/P1/P2 combined	1 A maximum

### **Physical Characteristics**

Printed circuit board dimensions	$9.9 \times 16.8$ cm ( $3.9 \times 6.6$ in.) (half-length)
Weight	169 g (5.9 oz)

 $<sup>^2</sup>$  Has self-resetting fuse that opens when current exceeds this specification.

Device connector	68-Pos Right Angle Dual Stack PCB-Mount VHDCI (Receptacle)
Cable connector	68-Pos Offset IDC Cable Connector (Plug) (SHC68-*)



**Note** For more information about the connectors used for DAQ devices, refer to the document, *NI DAQ Device Custom Cables, Replacement Connectors, and Screws*, by going to *ni.com/info* and entering the Info Code rdspmb.

Disk drive power connector	Standard ATX peripheral connector (not serial
	ATA)

### Calibration

Recommended warm-up time	15 minutes
Calibration interval	2 years

### Maximum Working Voltage

Maximum working voltage refers to the signal voltage plus the common-mode voltage.

```
Channel to earth
```

11 V, Measurement Category I

Measurement Category I is for measurements performed on circuits not directly connected to the electrical distribution system referred to as *MAINS* voltage. MAINS is a hazardous live electrical supply system that powers equipment. This category is for measurements of voltages from specially protected secondary circuits. Such voltage measurements include signal levels, special equipment, limited-energy parts of equipment, circuits powered by regulated low-voltage sources, and electronics.



**Caution** Do not connect the system to signals or use for measurements within Measurement Categories II, III, or IV.



**Note** Measurement Categories CAT I and CAT O are equivalent. These test and measurement circuits are for other circuits not intended for direct connection to the MAINS building installations of Measurement Categories CAT II, CAT III, or CAT IV.

## Environmental

Temperature	
Operating	0 °C to 50 °C
Storage	-40 °C to 70 °C
Humidity	
Operating	10% to 90% RH, noncondensing
Storage	5% to 95% RH, noncondensing
Pollution Degree	2
Maximum altitude	2,000 m

Indoor use only.

#### **Environmental Standards**

This product meets the requirements of the following environmental standards for electrical equipment.

- IEC 60068-2-1 Cold
- IEC 60068-2-2 Dry heat
- IEC 60068-2-56 Damp heat (steady state)

### Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1



**Note** For UL and other safety certifications, refer to the product label or the *Product Certifications and Declarations* section.

### **Electromagnetic Compatibility Standards**

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions

- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



**Note** In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia and New Zealand (per CISPR 11) Class A equipment is intended for use only in heavy-industrial locations.



**Notice** For EMC declarations and certifications, and additional information, refer to the *Product Certifications and Declarations* section.

# CE Compliance $C \in$

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)
- 2011/65/EU; Restriction of Hazardous Substances (RoHS)

### **Product Certifications and Declarations**

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit *ni.com/ certification*, search by model number or product line, and click the appropriate link in the Certification column.

### **Environmental Management**

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the *Minimize Our Environmental Impact* web page at *ni.com/environment*. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

#### Waste Electrical and Electronic Equipment (WEEE)

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